



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. :10/659,090 Confirmation No.:2724  
Applicant :Christopher J. Nagel  
Filed :September 10, 2003  
TC/A.U. :1751  
Examiner :Mark T. Kopec  
Docket No. :2751.2001 US2  
Title: COMPOSITION OF MATTER TAILORING: SYSTEM I

CERTIFICATE OF MAILING OR TRANSMISSION	
I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, or is being facsimile transmitted to the United States Patent and Trademark Office on:	
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**DECLARATION UNDER 37 CFR 1.132**

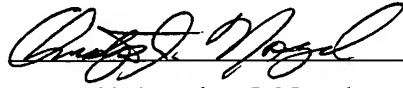
Sir:

I, Christopher J. Nagel, of 28 Highland Circle, Wayland MA 01778, am the sole inventor of the above identified application.

I am attaching an Excel spreadsheet of the data obtained from the following third party companies of the manufactured copper ingot (14-00-01) presented in the application: GDMS was obtained from SHIVA Technologies of Syracuse, New York; XRF was obtained from the University of Western Ontario, London, Ontario; PIXE was obtained from Elemental Analysis Incorporated, Lexington, Kentucky, and; GDOES was obtained from Twin Analytical of Independence, Ohio. The analysis is consistent with

the X-ray fluorescence (XRF) data presented in the application. The third party data confirmed that the manufactured copper ingot contains a different elemental signature that is different from the naturally occurring copper. The unique electronic characteristic of the manufactured copper is not a result from impurities but rather is an intrinsic property of the copper itself.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.



Christopher J. Nagel

